

# Technische Information / Technical Information

IGBT-Module  
IGBT-Modules

## BSM30GP60

eupec



### Elektrische Eigenschaften / Electrical properties

#### Höchstzulässige Werte / Maximum rated values

##### Diode Gleichrichter/ Diode Rectifier

Periodische Rückw. Spitzensperrspannung repetitive peak reverse voltage		$V_{RRM}$	1600	V
Durchlaßstrom Grenzeffektivwert RMS forward current per chip		$I_{FRMSM}$	40	A
Dauergleichstrom DC forward current	$T_C = 80^\circ\text{C}$	$I_d$	30	A
Stoßstrom Grenzwert surge forward current	$t_p = 10\text{ ms}, T_{vj} = 25^\circ\text{C}$	$I_{FSM}$	300	A
	$t_p = 10\text{ ms}, T_{vj} = 150^\circ\text{C}$		230	A
Grenzlastintegral $I^2t$ - value	$t_p = 10\text{ ms}, T_{vj} = 25^\circ\text{C}$	$I^2t$	450	$\text{A}^2\text{s}$
	$t_p = 10\text{ ms}, T_{vj} = 150^\circ\text{C}$		260	$\text{A}^2\text{s}$

##### Transistor Wechselrichter/ Transistor Inverter

Kollektor-Emitter-Sperrspannung collector-emitter voltage		$V_{CES}$	600	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 80^\circ\text{C}$	$I_{C,nom.}$	30	A
	$T_C = 25^\circ\text{C}$	$I_C$	50	A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1\text{ ms}, T_C = 80^\circ\text{C}$	$I_{CRM}$	60	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^\circ\text{C}$	$P_{tot}$	180	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		$V_{GES}$	+/- 20V	V

##### Diode Wechselrichter/ Diode Inverter

Dauergleichstrom DC forward current	$T_C = 80^\circ\text{C}$	$I_F$	30	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1\text{ ms}$	$I_{FRM}$	60	A
Grenzlastintegral $I^2t$ - value	$V_R = 0\text{V}, t_p = 10\text{ms}, T_{vj} = 125^\circ\text{C}$	$I^2t$	240	$\text{A}^2\text{s}$

##### Transistor Brems-Chopper/ Transistor Brake-Chopper

Kollektor-Emitter-Sperrspannung collector-emitter voltage		$V_{CES}$	600	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 80^\circ\text{C}$	$I_{C,nom.}$	15	A
	$T_C = 25^\circ\text{C}$	$I_C$	25	A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1\text{ ms}, T_C = 80^\circ\text{C}$	$I_{CRM}$	30	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^\circ\text{C}$	$P_{tot}$	100	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		$V_{GES}$	+/- 20V	V

##### Diode Brems-Chopper/ Diode Brake-Chopper

Dauergleichstrom DC forward current	$T_C = 80^\circ\text{C}$	$I_F$	10	A
Periodischer Spitzenstrom repetitive peak forw. current	$t_p = 1\text{ ms}$	$I_{FRM}$	20	A

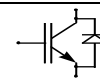
prepared by: Andreas Schulz	date of publication: 17.09.1999
approved by: M.Hierholzer	revision: 4

# Technische Information / Technical Information

IGBT-Module  
IGBT-Modules

## BSM30GP60

eupec



### Modul Isolation/ Module Isolation

Isolations-Prüfspannung insulation test voltage	RMS, f = 50 Hz, t = 1 min. NTC connected to Baseplate	$V_{ISOL}$	2,5	kV
--	--	------------	-----	----

### Elektrische Eigenschaften / Electrical properties

#### Charakteristische Werte / Characteristic values

##### Diode Gleichrichter/ Diode Rectifier

			min.	typ.	max.	
Durchlaßspannung forward voltage	$T_{vj} = 150^{\circ}\text{C}$ , $I_F = 30\text{ A}$	$V_F$	-	1,1	1,15	V
Schleusenspannung threshold voltage	$T_{vj} = 150^{\circ}\text{C}$	$V_{(TO)}$	-	-	0,8	V
Ersatzwiderstand slope resistance	$T_{vj} = 150^{\circ}\text{C}$	$r_T$	-	-	10,5	m $\Omega$
Sperrstrom reverse current	$T_{vj} = 150^{\circ}\text{C}$ , $V_R = 1600\text{ V}$	$I_R$	-	2	-	mA
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	$T_C = 25^{\circ}\text{C}$	$R_{AA'+CC'}$	-	8	-	m $\Omega$

##### Transistor Wechselrichter/ Transistor Inverter

			min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	$V_{GE} = 15\text{V}$ , $T_{vj} = 25^{\circ}\text{C}$ , $I_C = 30\text{ A}$	$V_{CE\text{ sat}}$	-	1,95	2,45	V
	$V_{GE} = 15\text{V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $I_C = 30\text{ A}$		-	2,2	-	V
Gate-Schwellenspannung gate threshold voltage	$V_{CE} = V_{GE}$ , $T_{vj} = 25^{\circ}\text{C}$ , $I_C = 0,7\text{ mA}$	$V_{GE(TO)}$	4,5	5,5	6,5	V
Eingangskapazität input capacitance	f = 1MHz, $T_{vj} = 25^{\circ}\text{C}$ $V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$	$C_{ies}$	-	1,6	-	nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	$V_{GE} = 0\text{V}$ , $T_{vj} = 25^{\circ}\text{C}$ , $V_{CE} = 600\text{ V}$	$I_{CES}$	-	1,0	500	$\mu\text{A}$
	$V_{GE} = 0\text{V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $V_{CE} = 600\text{ V}$		-	1,2	-	mA
Gate-Emitter Reststrom gate-emitter leakage current	$V_{CE} = 0\text{V}$ , $V_{GE} = 20\text{V}$ , $T_{vj} = 25^{\circ}\text{C}$	$I_{GES}$	-	-	300	nA
Einschaltverzögerungszeit (ind. Last) turn on delay time (inductive load)	$I_C = I_{Nenn}$ , $V_{CC} = 300\text{ V}$	$t_{d,on}$	-	50	-	ns
	$V_{GE} = \pm 15\text{V}$ , $T_{vj} = 25^{\circ}\text{C}$ , $R_G = 33\text{ Ohm}$					
	$V_{GE} = \pm 15\text{V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $R_G = 33\text{ Ohm}$					
Anstiegszeit (induktive Last) rise time (inductive load)	$I_C = I_{Nenn}$ , $V_{CC} = 300\text{ V}$	$t_r$	-	50	-	ns
	$V_{GE} = \pm 15\text{V}$ , $T_{vj} = 25^{\circ}\text{C}$ , $R_G = 33\text{ Ohm}$					
	$V_{GE} = \pm 15\text{V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $R_G = 33\text{ Ohm}$					
Abschaltverzögerungszeit (ind. Last) turn off delay time (inductive load)	$I_C = I_{Nenn}$ , $V_{CC} = 300\text{ V}$	$t_{d,off}$	-	250	-	ns
	$V_{GE} = \pm 15\text{V}$ , $T_{vj} = 25^{\circ}\text{C}$ , $R_G = 33\text{ Ohm}$					
	$V_{GE} = \pm 15\text{V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $R_G = 33\text{ Ohm}$					
Fallzeit (induktive Last) fall time (inductive load)	$I_C = I_{Nenn}$ , $V_{CC} = 300\text{ V}$	$t_f$	-	30	-	ns
	$V_{GE} = \pm 15\text{V}$ , $T_{vj} = 25^{\circ}\text{C}$ , $R_G = 33\text{ Ohm}$					
	$V_{GE} = \pm 15\text{V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $R_G = 33\text{ Ohm}$					
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	$I_C = I_{Nenn}$ , $V_{CC} = 300\text{ V}$ $V_{GE} = \pm 15\text{V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $R_G = 33\text{ Ohm}$ $L_S = 75\text{ nH}$	$E_{on}$	-	1,4	-	mWs
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	$I_C = I_{Nenn}$ , $V_{CC} = 300\text{ V}$ $V_{GE} = \pm 15\text{V}$ , $T_{vj} = 125^{\circ}\text{C}$ , $R_G = 33\text{ Ohm}$ $L_S = 75\text{ nH}$	$E_{off}$	-	1	-	mWs
Kurzschlußverhalten SC Data	$t_P \leq 10\mu\text{s}$ , $V_{GE} \leq 15\text{V}$ , $R_G = 33\text{ Ohm}$ $T_{vj} \leq 125^{\circ}\text{C}$ , $V_{CC} = 360\text{ V}$ $dI/dt = 1800\text{ A}/\mu\text{s}$	$I_{SC}$	-	120	-	A



**Elektrische Eigenschaften / Electrical properties**

**Charakteristische Werte / Characteristic values**

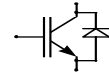
		min.	typ.	max.			
Modulinduktivität stray inductance module		$L_{\sigma CE}$	-	-	100 nH		
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	$T_C = 25^\circ C$	$R_{CC'+EE'}$	-	11	- mΩ		
<b>Diode Wechselrichter/ Diode Inverter</b>		<b>min.</b>		<b>typ.</b>		<b>max.</b>	
Durchlaßspannung forward voltage	$V_{GE} = 0V, T_{vj} = 25^\circ C, I_F = 30 A$ $V_{GE} = 0V, T_{vj} = 125^\circ C, I_F = 30 A$	$V_F$	-	1,25	1,7	V	
Rückstromspitze peak reverse recovery current	$I_F = I_{Nenn}, - di_F/dt = 900A/\mu s$ $V_{GE} = -10V, T_{vj} = 25^\circ C, V_R = 300 V$ $V_{GE} = -10V, T_{vj} = 125^\circ C, V_R = 300 V$	$I_{RM}$	-	26	-	A	
Sperrverzögerungsladung recovered charge	$I_F = I_{Nenn}, - di_F/dt = 900A/\mu s$ $V_{GE} = -10V, T_{vj} = 25^\circ C, V_R = 300 V$ $V_{GE} = -10V, T_{vj} = 125^\circ C, V_R = 300 V$	$Q_r$	-	2,5	-	μAs	
Abschaltenergie pro Puls reverse recovery energy	$I_F = I_{Nenn}, - di_F/dt = 900A/\mu s$ $V_{GE} = -10V, T_{vj} = 25^\circ C, V_R = 300 V$ $V_{GE} = -10V, T_{vj} = 125^\circ C, V_R = 300 V$	$E_{RO}$	-	0,5	-	mWs	
			-	0,8	-	mWs	
<b>Transistor Brems-Chopper/ Transistor Brake-Chopper</b>		<b>min.</b>		<b>typ.</b>		<b>max.</b>	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	$V_{GE} = 15V, T_{vj} = 25^\circ C, I_C = 15,0 A$ $V_{GE} = 15V, T_{vj} = 125^\circ C, I_C = 15,0 A$	$V_{CE sat}$	-	1,95	2,45	V	
Gate-Schwellenspannung gate threshold voltage	$V_{CE} = V_{GE}, T_{vj} = 25^\circ C, I_C = 0,4 mA$	$V_{GE(TO)}$	4,5	5,5	6,5	V	
Eingangskapazität input capacitance	$f = 1MHz, T_{vj} = 25^\circ C$ $V_{CE} = 25 V, V_{GE} = 0 V$	$C_{ies}$	-	0,8	-	nF	
Kollektor-Emitter Reststrom collector-emitter cut-off current	$V_{GE} = 0V, T_{vj} = 25^\circ C, V_{CE} = 600 V$ $V_{GE} = 0V, T_{vj} = 125^\circ C, V_{CE} = 600 V$	$I_{CES}$	-	0,5	500	μA	
Gate-Emitter Reststrom gate-emitter leakage current	$V_{CE} = 0V, V_{GE} = 20V, T_{vj} = 25^\circ C$	$I_{GES}$	-	-	300	nA	
<b>Diode Brems-Chopper/ Diode Brake-Chopper</b>		<b>min.</b>		<b>typ.</b>		<b>max.</b>	
Durchlaßspannung forward voltage	$T_{vj} = 25^\circ C, I_F = 15,0 A$ $T_{vj} = 125^\circ C, I_F = 15,0 A$	$V_F$	-	1,4	1,95	V	
			-	1,35	-	V	
<b>NTC-Widerstand/ NTC-Thermistor</b>		<b>min.</b>		<b>typ.</b>		<b>max.</b>	
Nennwiderstand rated resistance	$T_C = 25^\circ C$	$R_{25}$	-	5	-	kΩ	
Abweichung von $R_{100}$ deviation of $R_{100}$	$T_C = 100^\circ C, R_{100} = 493 \Omega$	$\Delta R/R$	-5		5	%	
Verlustleistung power dissipation	$T_C = 25^\circ C$	$P_{25}$			20	mW	
B-Wert B-value	$R_2 = R_1 \exp [B(1/T_2 - 1/T_1)]$	$B_{25/50}$		3375		K	

# Technische Information / Technical Information

IGBT-Module  
IGBT-Modules

## BSM30GP60

eupec

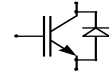


### Thermische Eigenschaften / Thermal properties

		min.	typ.	max.		
Innerer Wärmewiderstand thermal resistance, junction to case	Gleicher. Diode/ Rectif. Diode	$R_{thJC}$	-	-	1	K/W
	Trans. Wechr./ Trans. Inverter		-	-	0,7	K/W
	Diode Wechr./ Diode Inverter		-	-	1,2	K/W
	Trans. Bremse/ Trans. Brake		-	-	1,3	K/W
	Diode Bremse/ Diode Brake		-	-	2,3	K/W
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	Gleicher. Diode/ Rectif. Diode	$R_{thCK}$	-	0,08	-	K/W
	Trans. Wechr./ Trans. Inverter		-	0,04	-	K/W
	Diode Wechr./ Diode Inverter		-	0,08	-	K/W
Höchstzulässige Sperrschichttemperatur maximum junction temperature		$T_{vj}$	-	-	150	°C
Betriebstemperatur operation temperature		$T_{op}$	-40	-	125	°C
Lagertemperatur storage temperature		$T_{stg}$	-40	-	125	°C

### Mechanische Eigenschaften / Mechanical properties

Innere Isolation internal insulation				$Al_2O_3$	
CTI comperative tracking index				225	
Anzugsdrehmoment f. mech. Befestigung mounting torque		M		3 ±10%	Nm
Gewicht weight		G		180	g

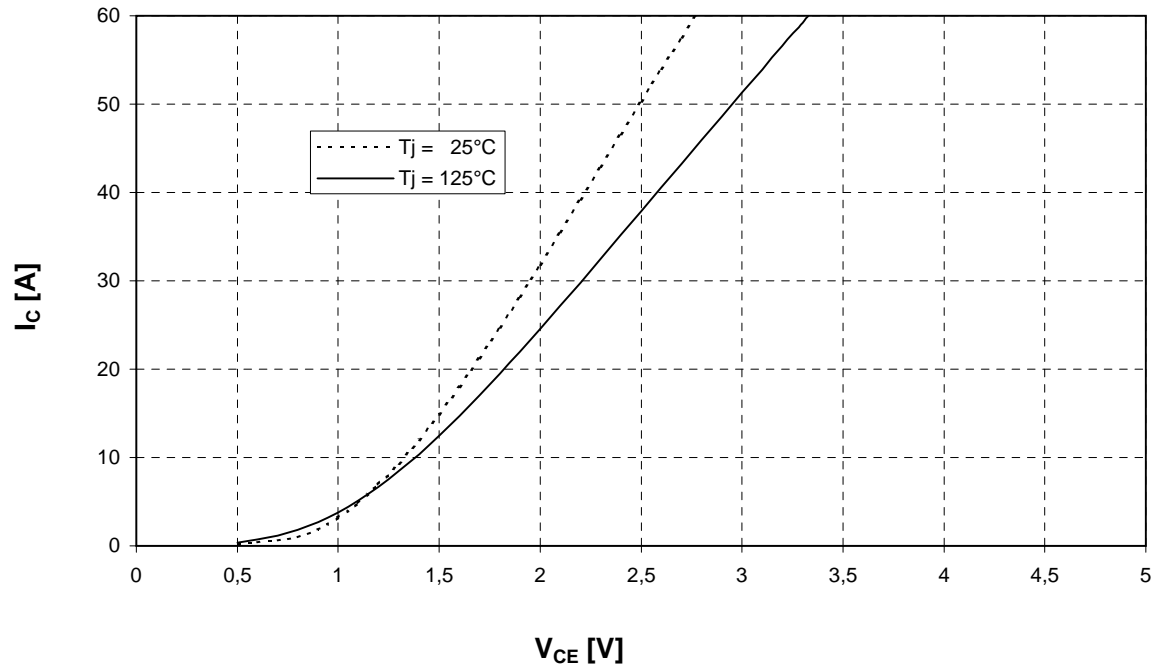


Ausgangskennlinienfeld Wechselr. (typisch)

$d = f(V_{CE})$

Output characteristic Inverter (typical)

$V_{GE} = 15\text{ V}$

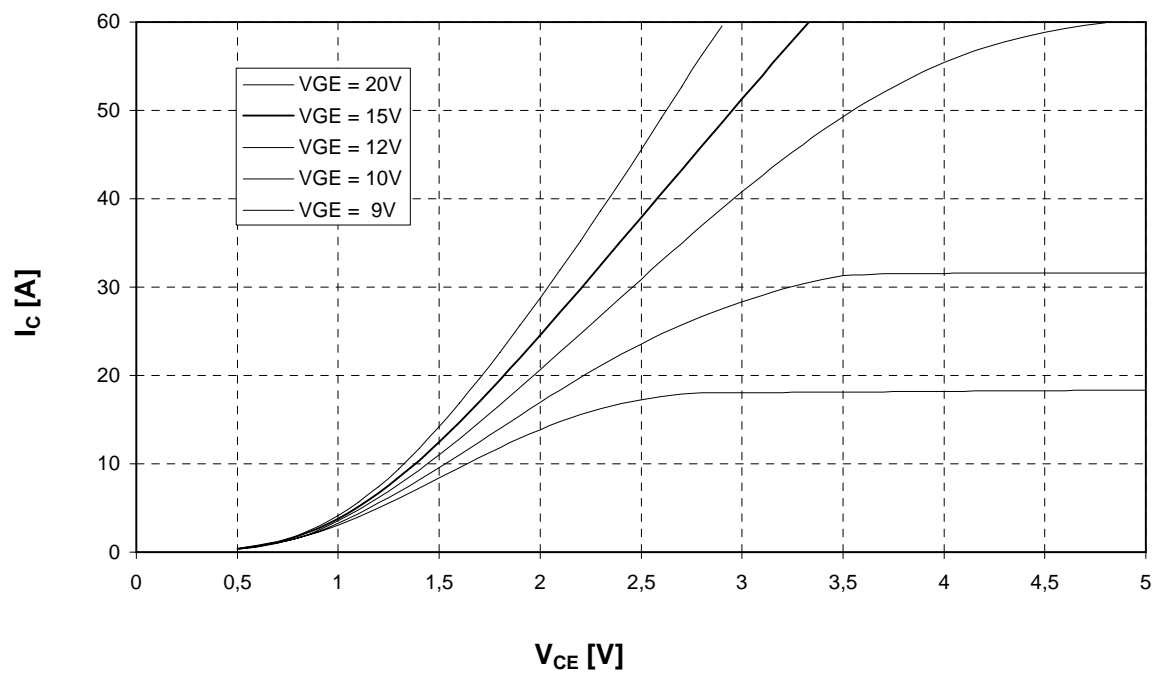


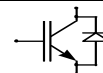
Ausgangskennlinienfeld Wechselr. (typisch)

$d = f(V_{CE})$

Output characteristic Inverter (typical)

$T_{vj} = 125^\circ\text{C}$



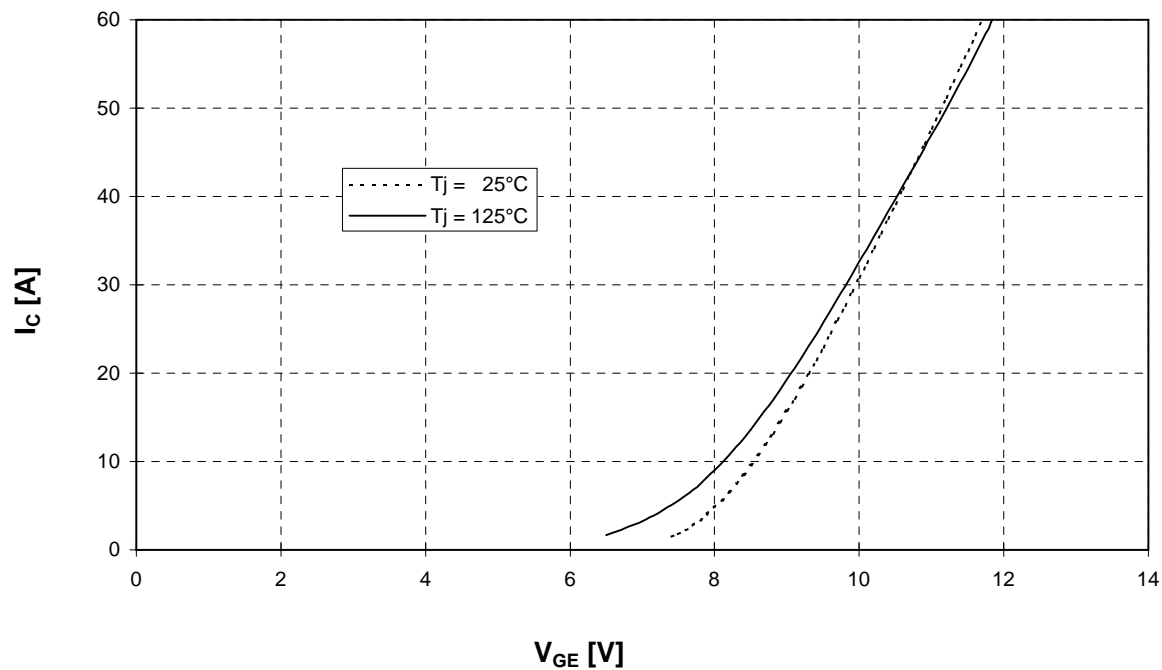


Übertragungscharakteristik Wechselr. (typisch)

Transfer characteristic Inverter (typical)

$$i_c = f(V_{GE})$$

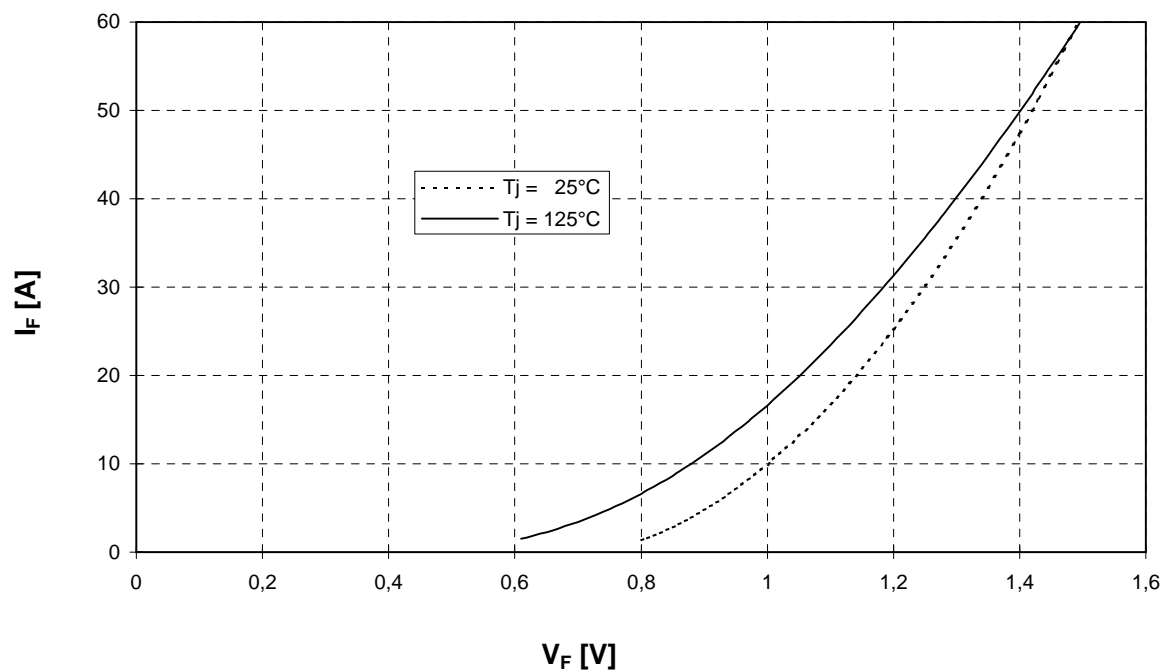
$$V_{CE} = 20 \text{ V}$$

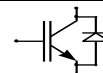


Durchlaßkennlinie der Freilaufdiode Wechselr. (typisch)

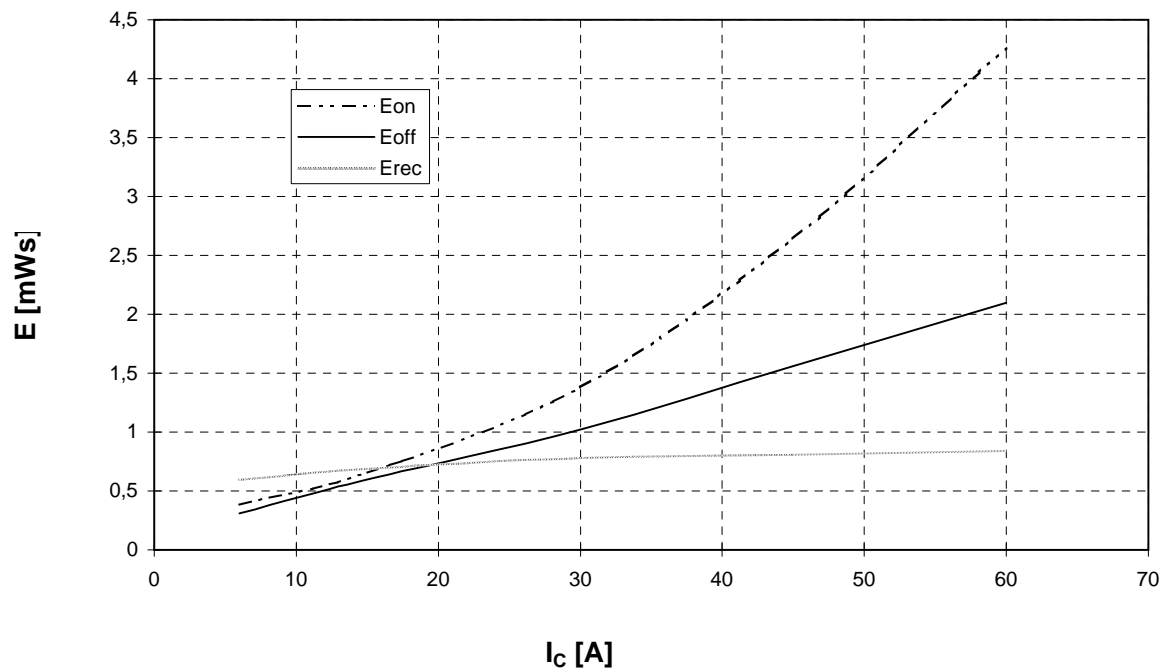
Forward characteristic of FWD Inverter (typical)

$$i_F = f(V_F)$$

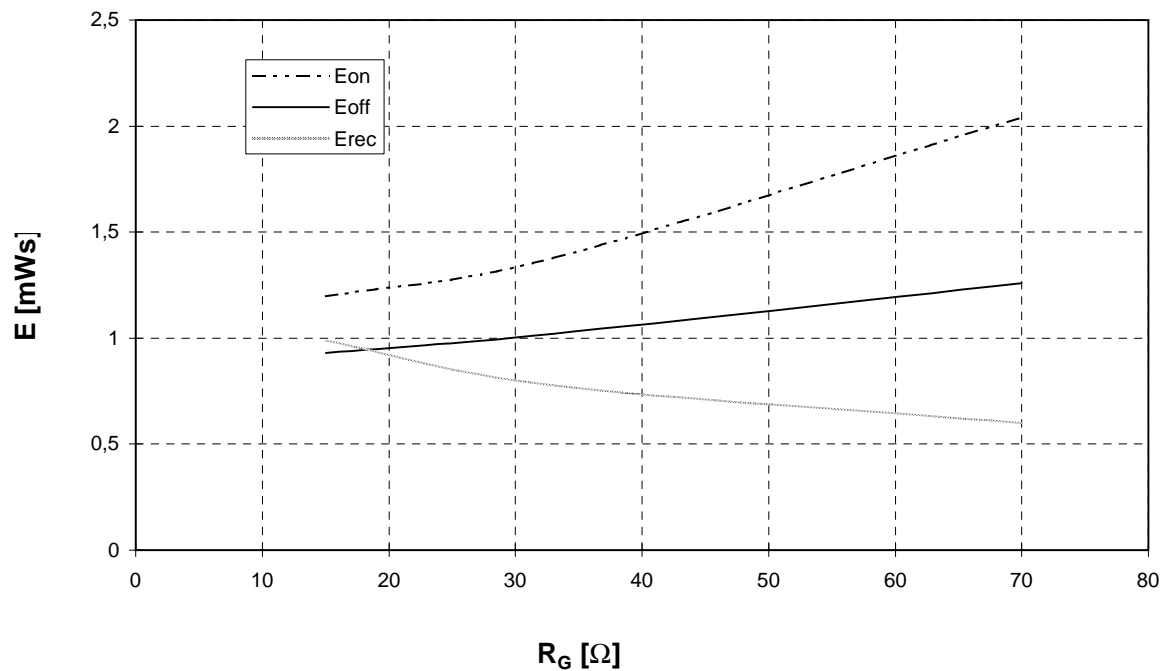


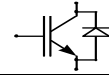


Schaltverluste Wechselr. (typisch)  $E_{on} = f(I_C), E_{off} = f(I_C), E_{rec} = f(I_C)$   $V_{CC} = 300\text{ V}$   
 Switching losses Inverter (typical)  $T_j = 125^\circ\text{C}, V_{GE} = \pm 15\text{ V}, R_{Gon} = R_{Goff} = 33\text{ Ohm}$



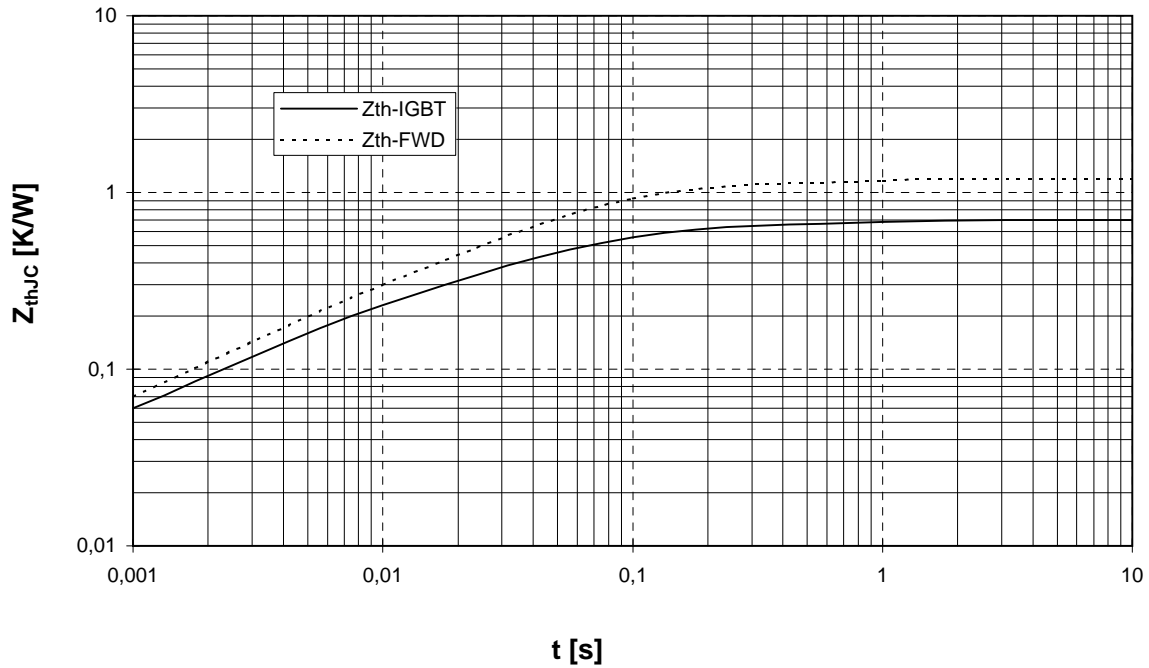
Schaltverluste Wechselr. (typisch)  $E_{on} = f(R_G), E_{off} = f(R_G), E_{rec} = f(R_G)$   
 Switching losses Inverter (typical)  $T_j = 125^\circ\text{C}, V_{GE} = \pm 15\text{ V}, I_C = I_{nenn}, V_{CC} = 300\text{ V}$





Transienter Wärmewiderstand Wechslr.  
Transient thermal impedance Inverter

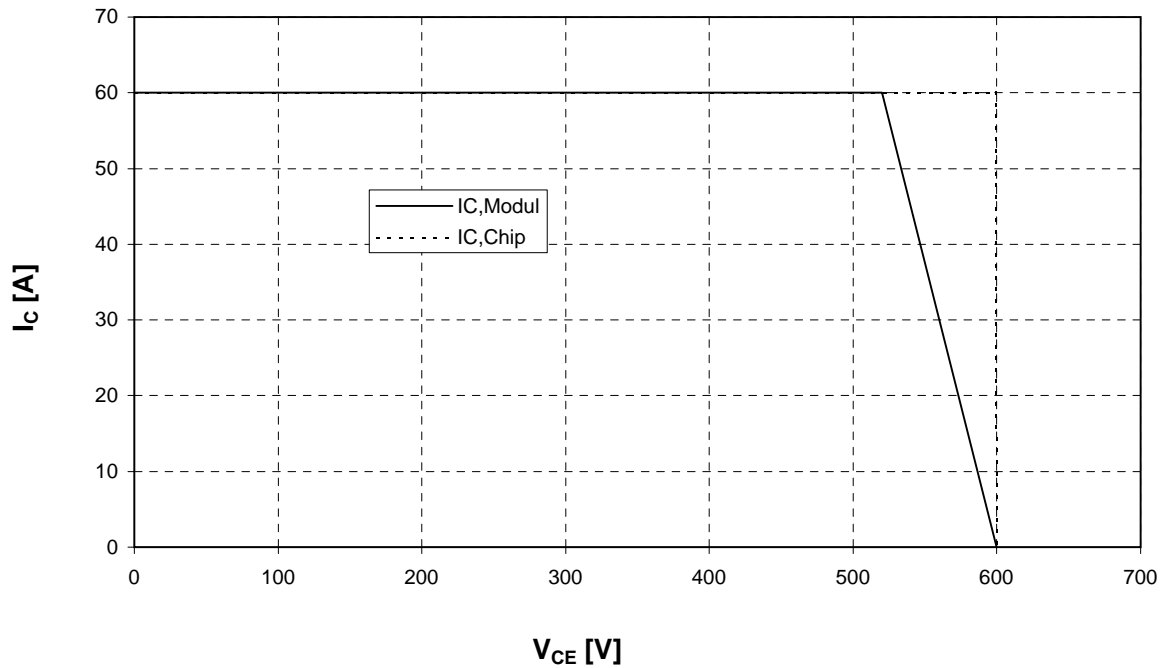
$$Z_{thJC} = f(t)$$



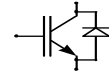
Sicherer Arbeitsbereich Wechslr. (RBSOA)

$$I_c = f(V_{CE})$$

Reverse bias safe operating area Inverter (RBSOA)  $T_{vj} = 125^\circ\text{C}$ ,  $V_{GE} = \pm 15\text{V}$ ,  $R_G = 33\ \Omega$





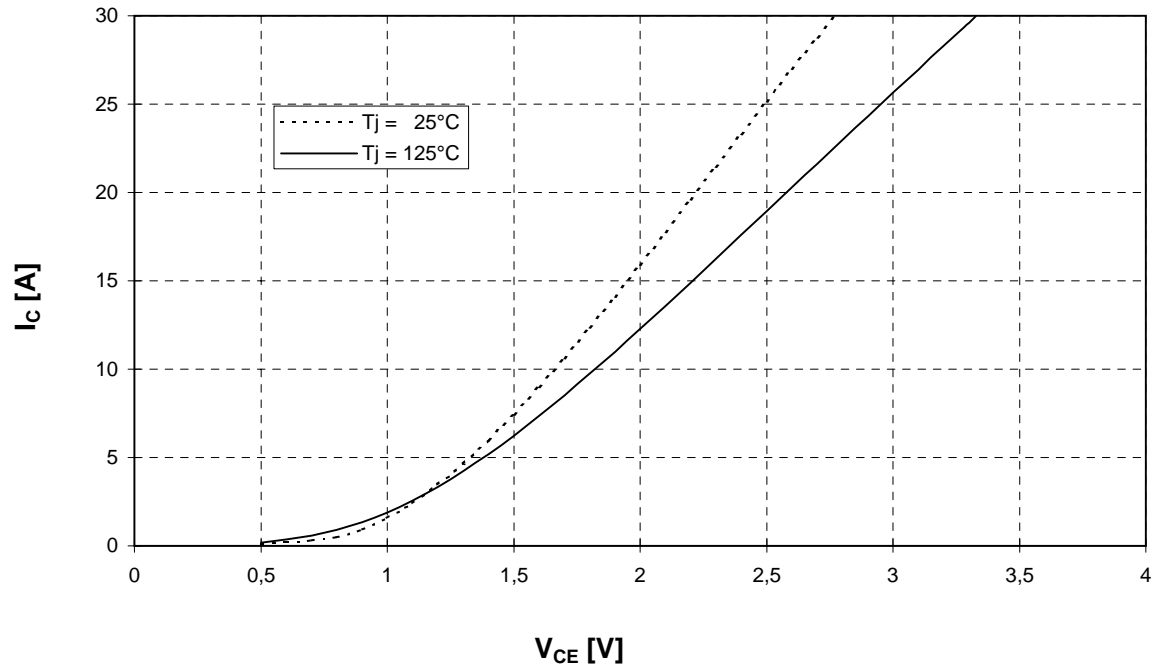


**Ausgangskennlinienfeld Brems-Chopper-IGBT (typisch)**

$d = f(V_{CE})$

**Output characteristic brake-chopper-IGBT (typical)**

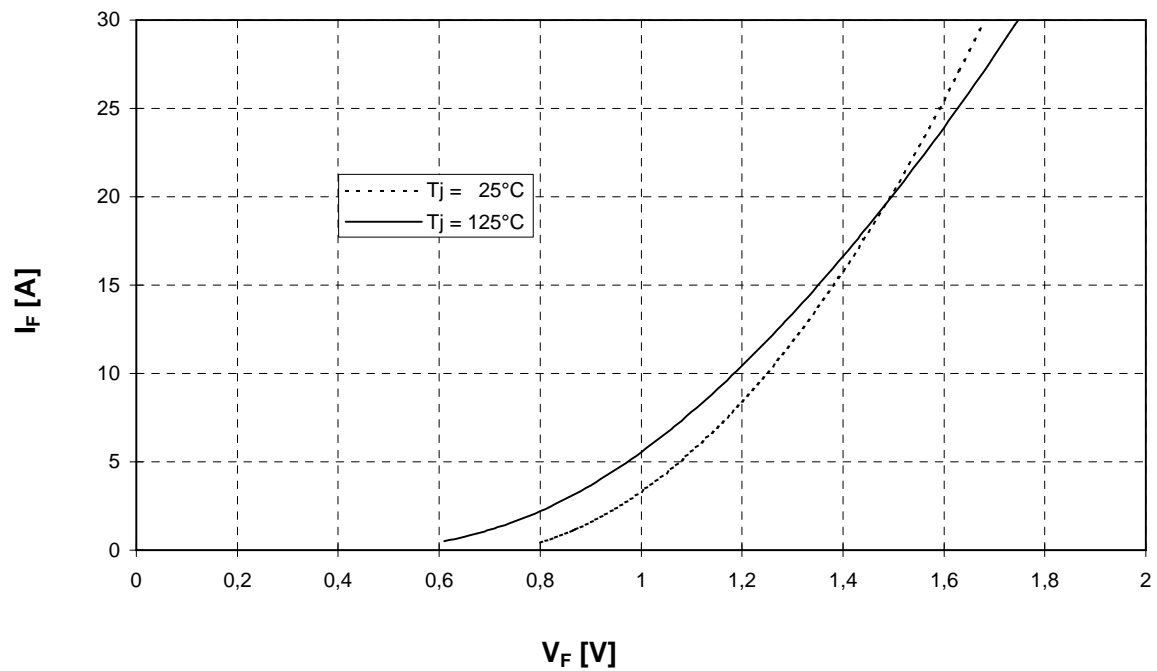
$V_{GE} = 15\text{ V}$



**Durchlaßkennlinie der Brems-Chopper-Diode (typisch)**

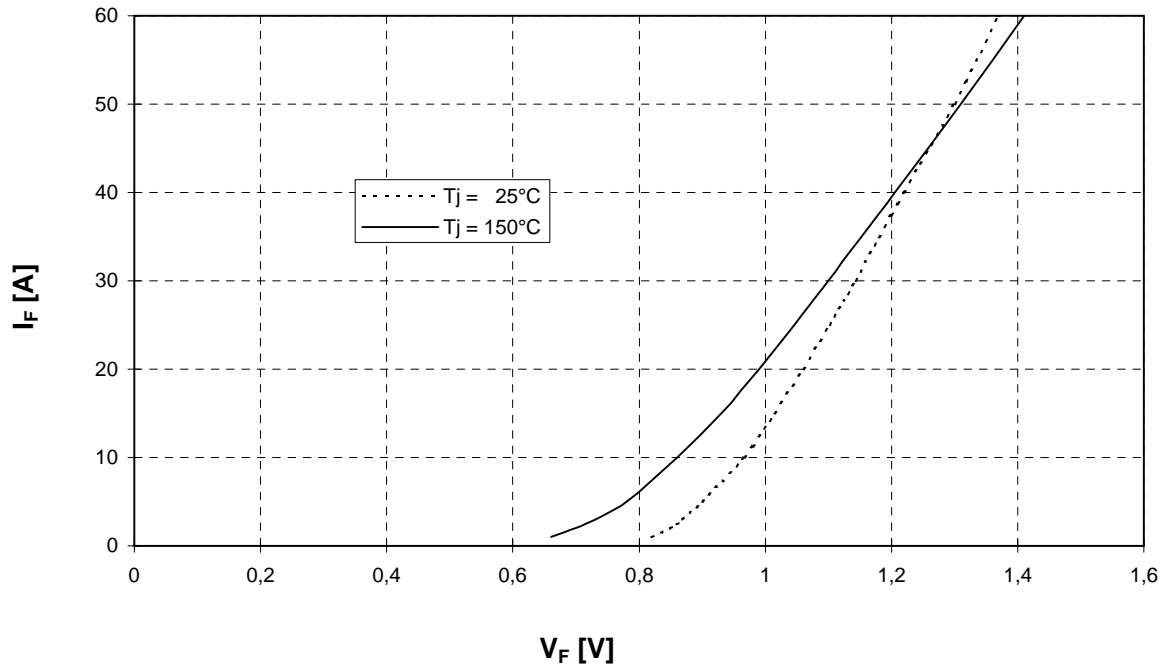
$i = f(V_F)$

**Forward characteristic of brake-chopper-FWD (typical)**

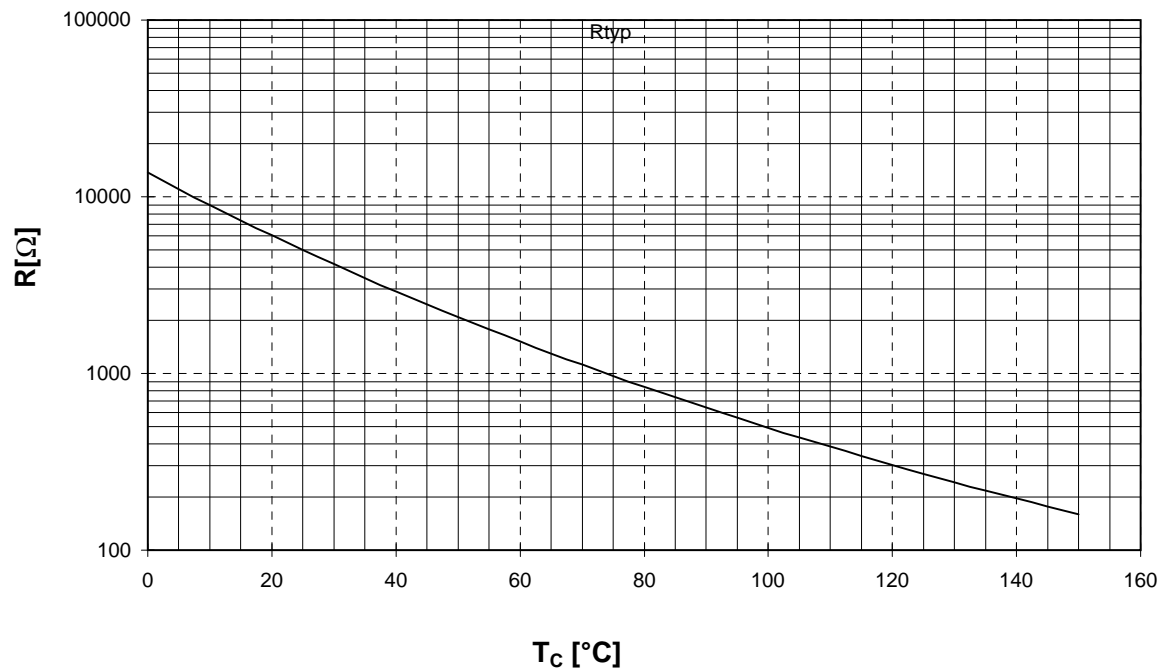


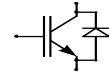


Durchlaßkennlinie der Gleichrichterdiode (typisch)  $\mu = f(V_F)$   
Forward characteristic of Rectifier Diode (typical)



NTC- Temperaturkennlinie (typisch)  $R = f(T)$   
NTC- temperature characteristic (typical)





Schaltplan/ Circuit diagram



Gehäuseabmessungen/ Package outlines



Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Sie gilt in Verbindung mit den zugehörigen Technischen Erläuterungen.

This technical information specifies semiconductor devices but promises no characteristics. It is valid in combination with the belonging technical notes.

## **Terms & Conditions of Usage**

### **Attention**

The present product data is exclusively subscribed to technically experienced staff. This Data Sheet is describing the specification of the products for which a warranty is granted exclusively pursuant the terms and conditions of the supply agreement. There will be no guarantee of any kind for the product and its specifications. Changes to the Data Sheet are reserved.

You and your technical departments will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to such application. Should you require product information in excess of the data given in the Data Sheet, please contact your local Sales Office via "[www.eupec.com / sales & contact](http://www.eupec.com / sales & contact)".

### **Warning**

Due to technical requirements the products may contain dangerous substances. For information on the types in question please contact your local Sales Office via "[www.eupec.com / sales & contact](http://www.eupec.com / sales & contact)".

## Данный компонент на территории Российской Федерации

### Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

moschip.ru\_6

moschip.ru\_9